Silicon NPN Triple Diffused

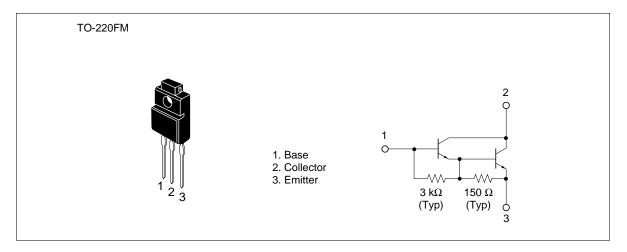
HITACHI

ADE-208-920 (Z) 1st. Edition Sep. 2000

Application

Low frequency power amplifier

Outline





Absolute Maximum Ratings (Ta = 25° C)

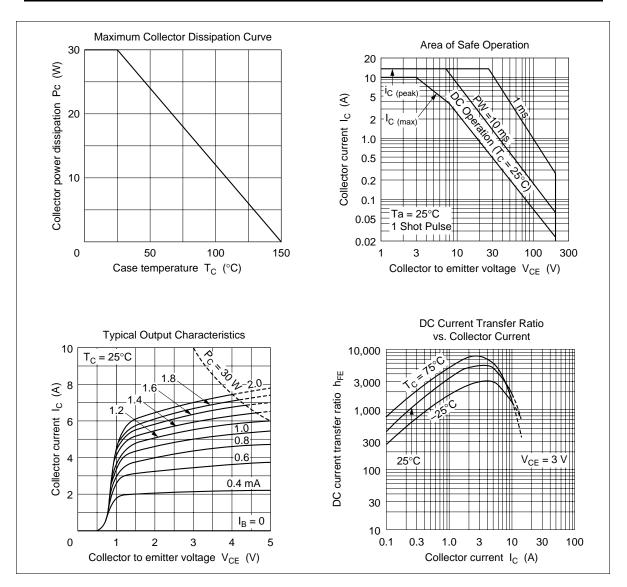
Symbol	Rating	Unit
V _{CBO}	200	V
V _{CEO}	200	V
V _{EBO}	7	V
Ι _c	10	А
I _{C(peak)}	15	А
Pc	2	W
P _c * ¹	30	
Tj	150	°C
Tstg	-55 to +150	°C
	$ \begin{array}{c} V_{CBO} \\ V_{CEO} \\ V_{EBO} \\ I_{C} \\ I_{C(peak)} \\ \hline P_{C} \\ P_{c}^{*1} \\ Tj \end{array} $	V _{CBO} 200 V_{CEO} 200 V_{EBO} 7 I_c 10 $I_{c(peak)}$ 15 P_c 2 P_c^{*1} 30 Tj 150

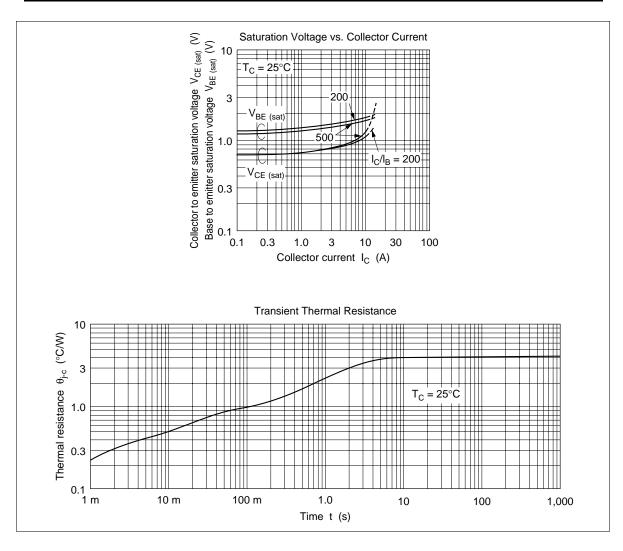
Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics (Ta = 25°C)

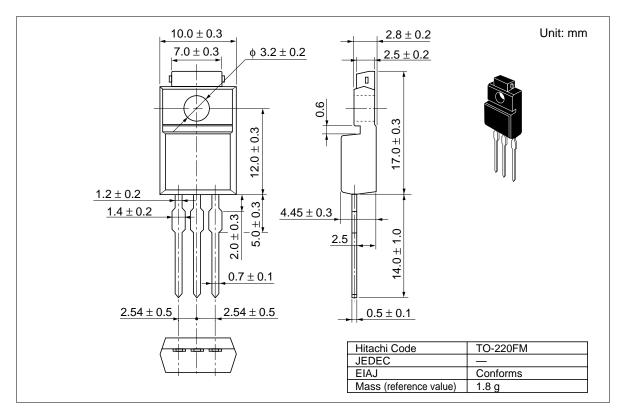
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	200	_	_	V	$I_{c} = 0.1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	200	_	_	V	$I_c = 25 \text{ mA}, \text{ R}_{\text{BE}} = \infty$
Collector to emitter sustain voltage	$V_{\text{CEO}(\text{SUS})}$	170	_	_	V	I _c = 5 A, L = 5 mH
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	—	—	V	$I_{\rm E} = 50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	10	μΑ	$V_{CB} = 180 \text{ V}, I_{E} = 0$
	I _{CEO}	—	_	50		V_{ce} = 180 V, R_{be} = ∞
DC current transfer ratio	h_{FE}	1500	_	—		$V_{ce} = 3 \text{ V}, \text{ I}_{c} = 5 \text{ A}^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)1}}$	—	—	1.5	V	$I_{\rm c} = 5 \text{ A}, I_{\rm B} = 10 \text{ mA}^{*1}$
voltage	$V_{\text{CE(sat)2}}$	_	—	3.0		$I_{\rm c} = 10 \text{ A}, I_{\rm B} = 100 \text{ mA}^{*1}$
Base to emitter saturation	$V_{\text{BE(sat)1}}$	_	—	2.0	V	$I_{\rm c} = 5 \text{ A}, I_{\rm B} = 10 \text{ mA}^{*1}$
voltage	$V_{\text{BE(sat)2}}$	_	_	3.5		$I_{\rm c} = 10$ A, $I_{\rm B} = 100$ mA ^{*1}

Note: 1. Pulse test.





Package Dimensions



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HITACHI Hitachi, Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL	NorthAmerica Europe		http://semiconductor.hitachi.com/ http://www.hitachi-eu.com/hel/ecg
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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Tel: <4>>

Hitachi Europe GmbH Electronic Components Group Dornacher Straβe 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel : <65>-538-6533/538-8577 Fax : <65>-538-6533/538-8577 URL : http://www.hitachi.com.sg

Hitachi Asia Ltd. (Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building, Taipei (105), Taiwan Tel : <886>-(2)-2718-3666 Fax : <886>-(2)-2718-3666 Fax : <886>-(2)-2718-8180 Telex : 23222 HAS-TP URL : http://www.hitachi.com.tw Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon, Hong Kong Tel : <852>-(2)-735-9218 Fax : <852>-(2)-730-0281 URL : http://www.hitachi.com.hk

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